# Very Low Forward Voltage Trench-based Schottky Rectifier

Exceptionally Low  $V_F = 0.50 \text{ V}$  at  $I_F = 5 \text{ A}$ 

#### **Features**

- Fine Lithography Trench-based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

#### **Typical Applications**

- Switching Power Supplies including Notebook/Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC-DC Converters
- Freewheeling and OR-ing Diodes
- Reverse Battery Protection
- Instrumentation

#### **Mechanical Characteristics**

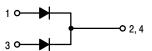
- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94–0 @ 0.125 in
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Maximum for 10 sec



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#### **PIN CONNECTIONS**





TO-220 CASE 221A STYLE 6

#### MARKING DIAGRAM



A = Assembly Location

Y = Year WW = Work Week AKA = Polarity Designator x = G or H

G = Pb–Free Package H = Halide–Free Package

## ORDERING INFORMATION

Device	Package	Shipping
NTSV20100CTG	TO-220 (Pb-Free)	50 Units / Rail

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V	
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 130°C)  Per device  Per diode	I <sub>F(AV)</sub>	20 10	A	
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 125°C) Per device Per diode	I <sub>FRM</sub>	40 20	A	
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	100	А	
Operating Junction Temperature	TJ	-40 to +150	°C	
Storage Temperature	T <sub>stg</sub>	-40 to +150	°C	
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Maximum Thermal Resistance Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	2.0 70	°C/W

### **ELECTRICAL CHARACTERISTICS** (Per Leg unless otherwise noted)

Rating	Symbol	Тур	Max	Unit
Maximum Instantaneous Forward Voltage (Note 1)	٧ <sub>F</sub>			V
$(I_F = 5 \text{ A}, T_J = 25^{\circ}\text{C})$		0.55	_	
$(I_F = 10 \text{ A}, T_J = 25^{\circ}\text{C})$		0.65	0.98	
$(I_F = 5 \text{ A}, T_J = 125^{\circ}\text{C})$ $(I_F = 10 \text{ A}, T_J = 125^{\circ}\text{C})$		0.50 0.58	_ 0.82	
Maximum Instantaneous Reverse Current (Note 1)	I <sub>R</sub>			
$(V_R = 70 \text{ V}, T_J = 25^{\circ}\text{C})$		17	_	μΑ
$(V_R = 70 \text{ V}, T_J = 125^{\circ}\text{C})$		5.3	_	mA
(Rated dc Voltage, T <sub>J</sub> = 25°C) (Rated dc Voltage, T <sub>J</sub> = 125°C)		_ 12	800 25	μA mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pulse Test: Pulse Width =  $300 \mu s$ , Duty Cycle  $\leq 2.0\%$ 

#### **TYPICAL CHARACTERISITICS**

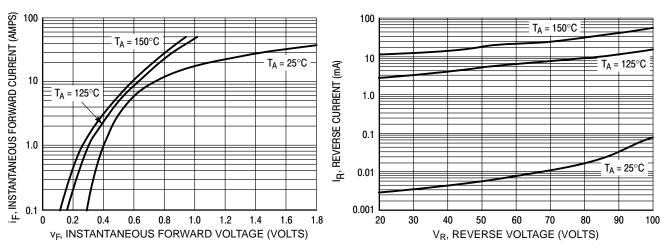
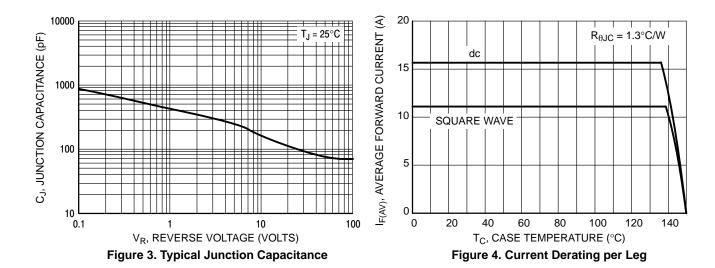
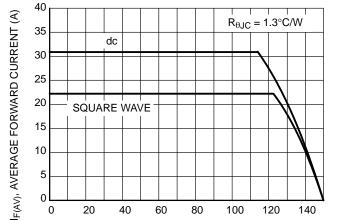


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current





T<sub>C</sub>, CASE TEMPERATURE (°C) Figure 5. Current Derating

80

100

120

140

60

20

0

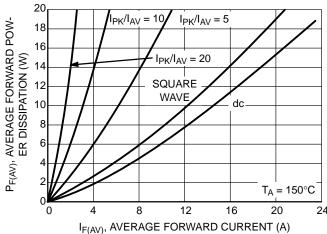


Figure 6. Forward Power Dissipation

### **TYPICAL CHARACTERISITICS**

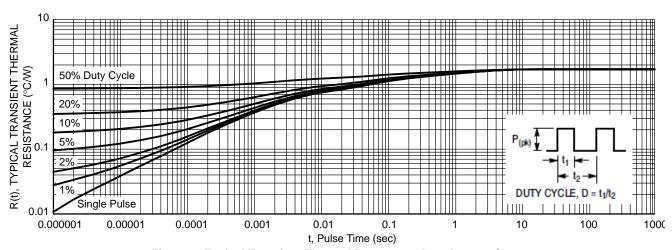
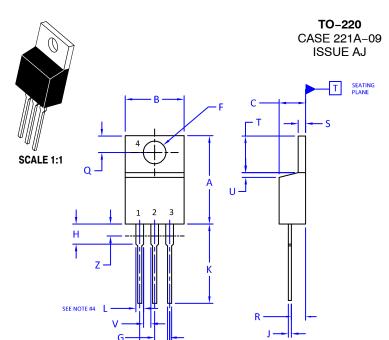


Figure 7. Typical Transient Thermal Response, Junction-to-Case





**DATE 05 NOV 2019** 

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: INCHES
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

#### 4. MAX WIDTH FOR F102 DEVICE = 1.35MM

	INCH	IES	MILLIMETERS	
DIM	MIN.	MAX.	MIN.	MAX.
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07 4.83	
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.60	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
К	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.41
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

	STYLE 2:		STYLE 3:		STYLE 4:	
BASE	PIN 1.	BASE	PIN 1.	CATHODE	PIN 1.	MAIN TERMINAL 1
COLLECTOR	2.	EMITTER	2.	ANODE	2.	MAIN TERMINAL 2
EMITTER	3.	COLLECTOR	3.	GATE	3.	GATE
COLLECTOR	4.	EMITTER	4.	ANODE	4.	MAIN TERMINAL 2
	STYLE 6:		STYLE 7:		STYLE 8:	
GATE	PIN 1.	ANODE	PIN 1.	CATHODE	PIN 1.	CATHODE
DRAIN	2.	CATHODE	2.	ANODE	2.	ANODE
SOURCE	3.	ANODE	3.	CATHODE	3.	EXTERNAL TRIP/DELA
DRAIN	4.	CATHODE	4.	ANODE	4.	ANODE
	STYLE 10:		STYLE 11:		STYLE 12	:
GATE	PIN 1.	GATE	PIN 1.	DRAIN	PIN 1.	MAIN TERMINAL 1
COLLECTOR	2.	SOURCE	2.	SOURCE	2.	MAIN TERMINAL 2
EMITTER	3.	DRAIN	3.	GATE	3.	GATE
COLLECTOR	4.	SOURCE	4.	SOURCE	4.	NOT CONNECTED
	COLLECTOR EMITTER COLLECTOR  GATE DRAIN SOURCE DRAIN  GATE COLLECTOR EMITTER	BASE         PIN 1.           COLLECTOR         2.           EMITTER         3.           COLLECTOR         4.           STYLE 6:         PIN 1.           GATE         PIN 1.           DRAIN         2.           SOURCE         3.           DRAIN         4.           STYLE 10:           GATE         PIN 1.           COLLECTOR         2.           EMITTER         3.	BASE	BASE COLLECTOR         PIN 1. 2. EMITTER         BASE 2. EMITTER         PIN 1. 2. EMITTER           GOLLECTOR         3. COLLECTOR         3.           COLLECTOR         4. EMITTER         4.           STYLE 7: GATE         STYLE 7: PIN 1. ANODE         PIN 1. PIN 1. GATE         STYLE 11: PIN 1. PIN	BASE	BASE

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